FEATURES AND SPECIFICATIONS

查询"46207-0106"供应商

4.20mm (.165") Pitch Mini-Fit RTC™ Vertical Headers

46207

Mini-Fit RTC has same features as Mini-Fit Jr.TM plus is RoHS capable

Designed with a high-temperature LCP housing, Mini-Fit RoHS Temperature Capable (RTC) Headers can withstand high SMT solder-reflow temperatures to guarantee compatibility with lead-free RoHS reflow processes.

Mini-Fit RTC headers mate with standard Mini-Fit[®] receptacles using the standard Mini-Fit key design. Mini-Fit RTC headers share the same design features of the Mini-Fit Jr. headers, ensuring compatibility and reliability.

Mini-Fit products provide a cost-effective solution for mid-range power applications that require high-density and current-carrying capability. For more information on Molex's extensive Mini-Fit product offering, visit www.molex.com/product/minifit.html.



Features and Benefits

- High-temperature LCP housing withstands RoHS lead-free processing up to 260° C peak
- Press-fit PCB pegs provide polarization during placement on the PCB and increased retention during the soldering process
- High-current Mini-fit Plus HCS™ male pins provide up to 12.0A per circuit (mated with Mini-Fit Plus HCS™ female crimp terminal, 16AWG)
- Mini-Fit locking thumb latch assures positive locking of mating connectors
- Standard Mini-Fit polarized, keyed silos prevent mismatching and provides protection for the mating terminals; compatible with existing Mini-Fit receptacles
- Circuit sizes 4 to 12, and 24, offer design flexibility; other sizes planned

SPECIFICATIONS

Reference Information

Packaging: Tray or box UL File No.: Contact Molex CSA File No.: Contact Molex Mates With: 5557 receptacle Designed In: Millimeters Process: Wave solder or SMT reflow, 260° C peak (20 seconds)

Electrical

Voltage: 600V Current: 12.0A Contact Resistance: 20 milliohms Dielectric Withstanding Voltage: 2200V AC Insulation Resistance: 1000 Megohms min.

Mechanical

Pin Retention to Housing: 6.67N (1.499 lb) min. Insertion Force to PCB: 55N (12.364 lb) max. 10.0N (2.248 lb) min. Mating Force: 14.7N (3.305 lb) max. Unmating Force: 1.0N (.225 lb) min.

Physical

Durability: 30 cycles

Housing: LCP, black Flammability: UL 94V-0 Contact: Brass Plating: Contact Area—Tin (Sn) Solder Tail Area—Tin (Sn) Underplating—Nickel (Ni) PCB Thickness: 1.57 and 2.36mm (.062" and .093") Operating Temperature: -40 to +105°C RoHS Capable: Yes



APPLICATIONS

查询"46207-0106"供应商

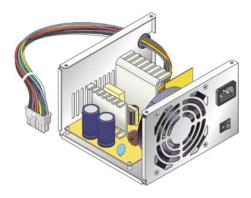
- Desktop/tower computer
- Power supplies
- Telecommunications
 - Hubs
 - Servers
- 📕 Industrial
- Medical
- Transportation
- Marine and recreational
- Military Commercial Off-the-Shelf (COTS)
- Mid-range power applications



Computer Tower



46207



PC Power Supply

ORDERING INFORMATION

Circuit	Order No.	
	1.57mm (.062") PCB Thickness	2.36mm (.093") PCB Thickness
4	46207-0004	46207-0104
6	46207-0006	46207-0106
8	46207-0008	46207-0108
10	46207-0010	46207-0110
12	46207-0012	46207-0112
24	46207-0024	46207-0124

Note: For additional circuit sizes, PCB thicknesses and plating contact Molex Inside Sales for more information.

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European Headquarters Munich, Germany 49-89-413092-0 eurinfo@molex.com Corporate Headquarters 2222 Wellington Ct. Lisle, IL 60532 U.S.A. 630-969-4550 Fax:630-969-1352

Order No. 987650-1133